

HZU Series

Silicon Planar Zener Diode for Stabilizer

REJ03G0625-0900 Rev.9.00 Jul 06, 2006

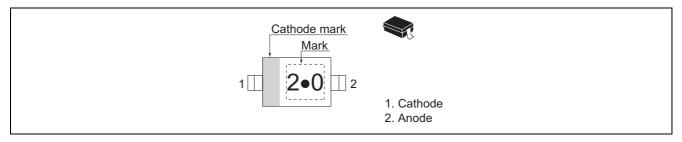
Features

- These diodes are delivered taped.
- Ultra small Resin Package (URP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Name	Package Code
HZU Series	Let to Mark Code	URP	PTSP0002ZA-A

Pin Arrangement



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Power dissipation	Pd * ¹	200	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. With P.C. Board.

Electrical Characteristics

 $(Ta = 25^{\circ}C)$

			Zener Volta	ge	Rever	se Current	Dynamic Resistance	
				Test		Test		Test
		V _z ((V)* ¹	Condition	I _R (μA)	Condition	r _d (Ω)	Condition
Type	Grade	Min	Max	I _Z (mA)	Max	V _R (V)	Max	I _Z (mA)
HZU2.0	В	1.90	2.20	5	120	0.5	100	5
HZU2.2	В	2.10	2.40	5	120	0.7	100	5
HZU2.4	В	2.30	2.60	5	120	1.0	100	5
HZU2.7	В	2.50	2.90	5	120	1.0	110	5
	B1	2.50	2.75					
	B2	2.65	2.90					
HZU3.0	В	2.80	3.20	5	50	1.0	120	5
	B1	2.80	3.05					
	B2	2.95	3.20					
HZU3.3	В	3.10	3.50	5	20	1.0	130	5
	B1	3.10	3.35	1				
	B2	3.25	3.50					
HZU3.6	В	3.40	3.80	5	10	1.0	130	5
	B1	3.40	3.65					
	B2	3.55	3.80					
HZU3.9	В	3.70	4.10	5	10	1.0	130	5
	B1	3.70	3.97					
	B2	3.87	4.10					
HZU4.3	В	4.01	4.48	5	10	1.0	130	5
	B1	4.01	4.21					
	B2	4.15	4.34					
	В3	4.28	4.48					
HZU4.7	В	4.42	4.90	5	10	1.0	130	5
	B1	4.42	4.61					
	B2	4.55	4.75					
	В3	4.69	4.90					
HZU5.1	В	4.84	5.37	5	5	1.5	130	5
	B1	4.84	5.04					
	B2	4.98	5.20					
	В3	5.14	5.37					
HZU5.6	В	5.31	5.92	5	5	2.5	80	5
	B1	5.31	5.55					
	B2	5.49	5.73					
	В3	5.67	5.92					

Note: 1. Tested with pulse ($P_W = 40 \text{ ms}$)

Type HZU6.2						_		
		V_ /	(V)* ¹	Test Condition	I- (11 A)	Test Condition	r. (O)	Test Condition
	Grade	Min	Max	I _z (mA)	I _R (μΑ) Max	V _R (V)	r _d (Ω) Max	I _z (mA)
	В	5.86	6.53	5	2	3.0	50	5
	B1	5.86	6.12		_	0.0		
	B2	6.06	6.33					
	B3	6.26	6.53					
HZU6.8	В	6.47	7.14	5	2	3.5	30	5
	B1	6.47	6.73	ŭ	_	0.0	00	
	B2	6.65	6.93					
	B3	6.86	7.14					
HZU7.5	В	7.06	7.84	5	2	4.0	30	5
	B1	7.06	7.36	ŭ	_		00	
	B2	7.28	7.60					
	B3	7.52	7.84					
HZU8.2	В	7.76	8.64	5	2	5.0	30	5
	B1	7.76	8.10	Ĭ	_	0.0	50	
-	B2	8.02	8.36	-				
	B3	8.28	8.64					
HZU9.1	В	8.56	9.55	5	2	6.0	30	5
B1 B2		8.56	8.93	3		0.0	30	3
		8.85	9.23					
	B3	9.15	9.55					
HZU10	В	9.45	10.55	5	2	7.0	30	5
	B1	9.45	9.87	3		7.0	30	3
	B2	9.77	10.21					
	B3	10.11	10.55					
HZU11	В	10.44	11.56	5	2	8.0	30	5
112011	B1	10.44	10.88	J	_	0.0	00	J
-	B2	10.76	11.22					
	B3	11.10	11.56					
HZU12	В	11.42	12.60	5	2	9.0	35	5
112012	B1	11.42	11.90	3		0.0	33	5
	B2	11.74	12.24					
	B3	12.08	12.60					
HZU13	В	12.47	13.96	5	2	10.0	35	5
112010	B1	12.47	13.03	3		10.0	33	3
	B2	12.91	13.49					
	B3	13.37	13.96					
HZU15	В	13.84	15.52	5	2	11.0	40	5
0.10	B1	13.84	14.46		_	11.0	7∪	
ŀ	B2	14.34	14.98					
	B3	14.85	15.52					
HZU16	В	15.37	17.09	5	2	12.0	40	5
0.10	B1	15.37	16.01	, ,	_	12.0	⊤ ∪	
ŀ	B2	15.58	16.51					
	B3	16.35	17.09					
HZU18	В	16.94	19.03	5	2	13.0	45	5
112010	B1	16.94	17.70	,	_	13.0	1 0	5
	B2	17.56	18.35					
	B3	18.21	19.03					

Note: 1. Tested with pulse $(P_W = 40 \text{ ms})$

		Zener Voltage			Reverse Current		Dynamic Resistance	
				Test		Test		Test
		V _z (V)* ¹	Condition	I _R (μA)	Condition	r _d (Ω)	Condition
Type	Grade	Min	Max	I _Z (mA)	Max	V _R (V)	Max	I _z (mA)
HZU20	В	18.86	21.08	5	2	15.0	50	5
	B1	18.86	19.70					
	B2	19.52	20.39					
	В3	20.21	21.08					
HZU22	В	20.88	23.17	5	2	17.0	55	5
	B1	20.88	21.77					
	B2	21.54	22.47					
	В3	22.23	23.17					
HZU24	В	22.93	25.57	5	2	19.0	60	5
	B1	22.93	23.96					
	B2	23.72	24.78					
	В3	24.54	25.57					
HZU27	В	25.10	28.90	2	2	21.0	70	2
HZU30	В	28.00	32.00	2	2	23.0	80	2
HZU33	В	31.00	35.00	2	2	25.0	80	2
HZU36	В	34.00	38.00	2	2	27.0	90	2

Note: 1. Tested with pulse ($P_W = 40 \text{ ms}$).

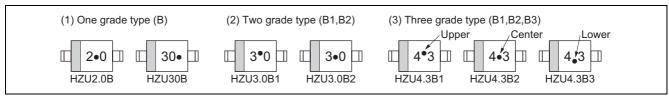
Mark Code

Туре	Grade	Mark No.
HZU2.0	В	2 · 0
HZU2.2	В	2 · 2
HZU2.4	В	2 · 4
HZU2.7	B1	2 · 7
	B2	2 · 7
HZU3.0	B1	3 · 0
	B2	3 · 0
HZU3.3	B1	3 · 3
	B2	3 · 3
HZU3.6	B1	3 · 6
	B2	3 · 6
HZU3.9	B1	3 · 9
	B2	3 · 9
HZU4.3	B1	4 · 3
	B2	4 · 3
	В3	4 · 3
HZU4.7	B1	4 · 7
	B2	4 · 7
	В3	4 · 7
HZU5.1	B1	5 · 1
	B2	5 · 1
	В3	5 · 1
HZU5.6	B1	5 · 6
	B2	5 · 6
	В3	5 · 6

Type	Grade	Mark No.
HZU6.2	B1	6 · 2
	B2	6 · 2
	В3	6 · 2
HZU6.8	B1	6 · 8
	B2	6 · 8
	В3	6 · 8
HZU7.5	B1	7 · 5
	B2	7 · 5
	В3	7 · 5
HZU8.2	B1	8 · 2
	B2	8 · 2
	В3	8 · 2
HZU9.1	B1	9 · 1
	B2	9 · 1
	В3	9 · 1
HZU10	B1	10.
	B2	10.
	В3	10.
HZU11	B1	11.
	B2	11.
	В3	11.
HZU12	B1	12.
	B2	12.
	В3	12.

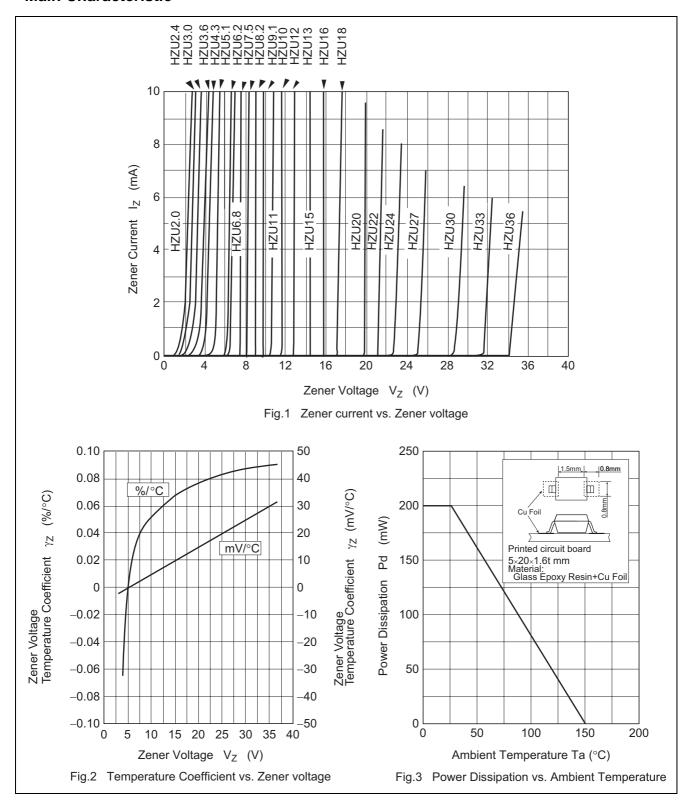
Туре	Grade	Mark No.
HZU13	B1	13.
	B2	13.
	В3	13.
HZU15	B1	15.
	B2	15.
	В3	15.
HZU16	B1	16.
	B2	16.
	В3	16.
HZU18	B1	18.
	B2	18.
	В3	18.
HZU20	B1	20.
	B2	20.
	В3	20.
HZU22	B1	22.
	B2	22.
	В3	22.
HZU24	B1	24.
	B2	24.
	В3	24.
HZU27	В	27.
HZU30	В	30.
HZU33	В	33.
HZU36	В	36.

Notes: 1. Example of Marking

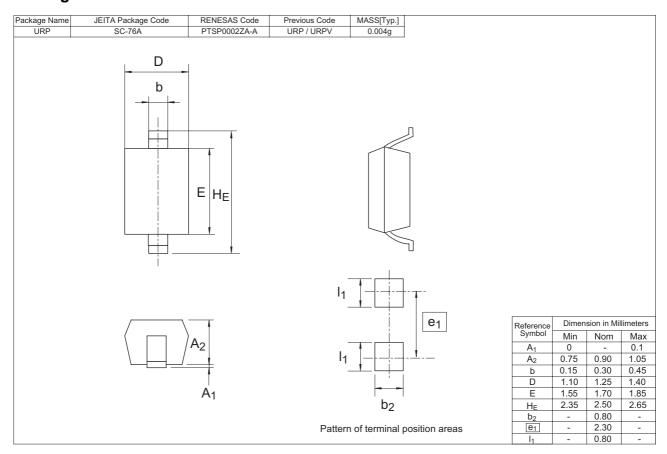


- 2. The grade B type includes from B1 min. to B3 (or B2) max.
- 3. B grade is standard and has better delivery, these are marked one of B1, B2, B3.
- 4. Type No. is as follows; HZU2.0B, HZU2.2B, ••• HZU36B. (B grade)
- 5. Type No. is as follows; HZU2.7B1, HZU2.7B2, ••• HZU24B3. (B 1, B2, B3 grade)

Main Characteristic



Package Dimensions



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